Appl. No. 10/559,915 Response to Office Action Dated June 9, 2009

1. Amendments to the Claims:

A clean version of the entire set of pending claims (including amendments to the claims, if any) is submitted herewith per 37 CFR § 1.121(c)(3). This listing of claims will replace all prior versions, and listings, of claims in the application.

Listing of Claims:

 (Currently amended) A method of manufacturing a device having a magnetic layerstructure, the method comprising:

forming the magnetic layer-structure;

heating the magnetic layer-structure with an electric current, the electric current comprising a current pulse having a duration such that no substantial heat transfer from the magnetic layer-structure to an environment of the magnetic layer-structure takes place, so that a temperature of the environment before and after the current pulse is substantially the same; and

selecting a physical process of a <u>plurality of physical processes having corresponding activation energies</u> in the magnetic layer-structure based on the current pulse, a duration and an amplitude of the current pulse being adapted to an activation energy of the selected physical process.

- (Previously presented) The method as claimed in claim 1, wherein the heat is transferred by means of heat conduction.
- 3. (Previously presented) The method as claimed in claim 1, wherein selecting the physical process in the magnetic layer-structure comprises selecting a layer physical process in one magnetic layer of the magnetic layer-structure, based on the duration and amplitude of the current pulse.

Appl. No. 10/559,915 Response to Office Action Dated June 9, 2009

- (Previously presented) The method as claimed in claim 1, wherein selecting the
 physical process comprises increasing the amplitude and decreasing the pulse duration of the
 current pulse.
- (Previously presented) The method as claimed in claim 1, wherein the electric current comprises a sequence of current pulses, which is applied without substantial heat transfer from the magnetic layer-structure to the environment.
- (Previously presented) The method as claimed in claim 1, wherein the device comprises a magnetoresistive device.
- (Previously presented) The method as claimed in claim 6, herein the device is a sensing device.
- 8. (Previously presented) The method as claimed in claim 1, wherein the magnetic layer-structure comprises at least one bias layer, the method further comprising: applying a magnetic field to the at least one bias layer during the current pulse; and switching off the magnetic field after a temperature of the bias layer decreases to below Néel or Curie temperature.
- (Previously presented) A method of manufacturing a magnetoresistive sensor device having a magnetic layer-structure, the method comprising:

forming the magnetic layer-structure; and

heating the magnetic layer-structure with an electric current, the electric current comprising a current pulse having a duration that prevents substantial heat transfer from the magnetic layer-structure to an environment of the magnetic layer-structure, so that a temperature of the environment before and after the current pulse is substantially the same.

wherein the magnetic layer-structure comprises a first bias layer having a first antiferromagnetic material with a first blocking temperature and a second bias layer having a Appl. No. 10/559,915 Response to Office Action Dated June 9, 2009

having a second antiferromagnetic material with a second blocking temperature different from the first blocking temperature, a magnetization direction of the first or second antiferromagnetic material having the higher blocking temperature being set before a magnetization direction of the first or second antiferromagnetic material having the lower blocking temperature is set.

- (Previously presented) The method as claimed claim 1, wherein a duration of the current pulse is shorter than 100 ms.
- (Previously presented) The method as claimed in claim 8, wherein the device is included in a magnetic system having a plurality of magnetoresistive devices.
- 12. (Previously presented) The method as claimed in claim 11, wherein the magnetic system comprises at least four magnetoresistive devices, arranged in a Wheatstone bridge configuration.
- 13. (Previously presented) A method of manufacturing a magnetoresistive bridge device of a magnetic system comprising a plurality of magnetoresistive bridge devices, the method comprising:

forming a magnetic layer-structure; and

heating the magnetic layer-structure with an electric current, the electric current comprising a current pulse having a duration that prevents substantial heat transfer from the magnetic layer-structure to an environment of the magnetic layer-structure, so that a temperature of the environment before and after the current pulse is substantially the same.

wherein the current pulse is applied for offset compensation by irreversibly changing a resistance of at least one of the magnetoresistive bridge devices through local heating.

14-15. (Cancelled)